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U.S. DEPARTMENT OF COMMERCE  
PATENT AND TRADEMARK OFFICE

PATENT APPLICATION TRANSMITTAL LETTER

ATTORNEY DOCKET NUMBER:

2338/46601

Assistant Commissioner for Patents  
Washington D.C. 20231

Transmitted herewith for filing is the patent application of

Inventor(s): **Konstantinos E. Spartiotis, Jaakko Salonen**For: **Bump-Bonded Semiconductor Imaging Device**

Enclosed are:

1. 15 sheets of specification, 5 sheet(s) of claims, and 1 sheet of abstract.
2. 3 sheet(s) of drawings.
3. Small Entity Declaration.
4. Information Disclosure Statement and PTO-1449 with 8 References.

The filing fee has been calculated as shown below:

NUMBER FILED

NUMBER  
EXTRA\*

RATE (\$)

FEE (\$)

BASIC FEE

790.00

790.00

TOTAL CLAIMS

31 =

0

22.00

242.00

INDEPENDENT CLAIMS

3 =

0

82.00

0.00

MULTIPLE DEPENDENT CLAIM PRESENT

.00

FEE FOR RECORDATION OF ASSIGNMENT

40.00

0.00

Number extra must be zero or larger

TOTAL

1032.00

If applicant is a small entity under 37 C.F.R. §§ 1.9  
and 1.27, then divide total fee by 2, and enter amount here.SMALL ENTITY  
TOTAL

516.00

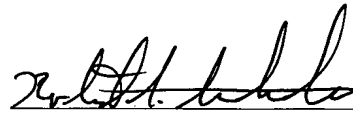
5. Please charge the required fee of \$516.00 to the deposit account of **Kenyon & Kenyon**, deposit account number 11-0600.  
A duplicate copy of this sheet is enclosed.

6. The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to the deposit account of **Kenyon & Kenyon**, deposit account number 11-0600.

- a. Any additional filing fees required under 37 C.F.R. § 1.16.
- b. Any patent application processing fees under 37 C.F.R. § 1.17.

Dated: November 12, 1997

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DC1-146432